



Recommended PCB Layout  
(T=1.0~1.2mm,Tol:±0.05)

- NOTES:
- MATERIAL
    - HOUSING:HIGH THERMAL PLASTIC,BLACK,UL94 V-0
    - CONTACT:COPPER ALLOY,CONTACT AREA:PLATING G/F,SOLDER AREA: PLATING SN 80U"MIN.
    - SHELL:COPPER ALLOY,PLATING NI 30U"MIN.
    - LED:GREEN AND YELLOW
  - ELECTRICAL :
    - CURRENT RATING: 1.5A MAX.
    - VOLTAGE RATING :150V AC MIN. (RMS)
    - WITHSTANDING VOLTAGE: 1000V AC FOR 1 MINUTE
    - INSULATION RESISTANCE: 500MΩ MIN.
    - CONTACT RESISTANCE: 40mΩ MAX.
  - ENVIRONMENTAL:
    - OPERATING TEMPERATURE: -40°C TO +85°C

RoHS Compliant		<b>HSM</b> 玄茂科技股份有限公司 <b>HSUAN MAO TECHNOLOGY CO., LTD.</b>	
APPD. 核准 Betty	SCALE 比例 参考 UNIT 單位 M M PAGE 張數 1 OF 1	TOLERANCE UNLESS SPECIFIED: .000 ± 0.15 .00 ± 0.25 .0 ± 0.35 .0 ± 0.50 ANGLE ± 2° SIZE. 紙張尺寸 A 4 REV. 版次 A	PART NAME 品名 SIDE ENTRY MODULAR JACK OFFSET TYPE 8P8C DIP TYPE WITH SHIELDED WITH LED (LEFT:GREEN/RIGHT:YELLOW) BLACK COLOR TRAY PACKING ROHS PART NO. 料號 C0047-88YX01B0R

